

# **DATASHEET**

# 6 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER AC INPUT PHOTOCOUPLER H11AAX Series



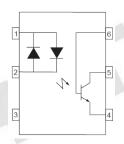




#### Features:

- H11AAX series: H11AA1, H11AA2, H11AA3, H11AA4
- High isolation voltage between input and output Viso = 5000 Vrms
- Creepage distance >7.62 mm
- · Compact dual-in-line package
- Pb free and RoHS compliant.
- UL and cUL approved(No. E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

#### Schematic



#### Pin Configuration

- 1. Anode / Cathode
- 2. Cathode / Anode
- 3. No Connection
- 4. Emitter
- 5. Collector
- 6. Base

#### **Description**

The H11AAX series of devices each consist of two infrared emitting diode, connected in inverse parallel, optically coupled to a phototransistor detector.

They are packaged in a 6-pin DIP package and available in wide-lead spacing and SMD option.

#### **Applications**

- AC line monitor
- Unknown polarity DC sensor
- Telephone line interface

LifecyclePhase: Approved



# Absolute Maximum Ratings (Ta=25)

	Parameter	Symbol	Rating	Unit
	Forward current	I <sub>F</sub>	60	mA
lancit.	Peak forward current (t = 10µs)	I <sub>FM</sub>	1	А
Input	Power dissipation (TA = 25°C)	-	120	mW
	Derating factor (above 90°C)	P <sub>D</sub> —	3.8	mW/°C
Output	Power dissipation (T <sub>A</sub> = 25°C) No derating up to 100°C	P <sub>C</sub>	150	mW
	Collector-Emitter voltage	V <sub>CEO</sub>	80	V
	Collector-Base voltage	$V_{CBO}$	80	V
	Emitter-Collector voltage	V <sub>ECO</sub>	7	V
Total Power Dissipation		P <sub>TOT</sub>	200	mW
Isolation Voltage*1		V <sub>ISO</sub>	5000	V rms
Operating Temperature		$T_OPR$	-55 to 100	°C
Storage Temperature		T <sub>STG</sub>	-55 to 125	°C
Soldering Temperature*2		T <sub>SOL</sub>	260	°C

#### Notes:

<sup>\*1</sup> AC for 1 minute, R.H.=  $40 \sim 60\%$  R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

<sup>\*2</sup> For 10 seconds



#### **Electro-Optical Characteristics (Ta=25** unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{F}$	-	1.2	1.5	V	$I_F = \pm 10 \text{mA}$
Input capacitance	C <sub>in</sub>	-	80	-	pF	V = 0, f = 1MHz

Output

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Emitter dark current	I <sub>CEO</sub>	-	-	50	nA	$V_{CE} = 10V, I_F = 0mA$
Collector-Emitter breakdown voltage	$BV_CEO$	80	-	-	V	$I_C = 1 \text{mA}$
Collector-Base breakdown voltage	$BV_CBO$	80	-	-	V	I <sub>C</sub> = 0.1mA
Emitter-Collector breakdown voltage	$BV_{ECO}$	7	-	-	V	I <sub>E</sub> = 0.1mA
Collector-Emitter capacitance	C <sub>CE</sub>	-	10	-	pF	VCE = 0V, f = 1MHz
Transfer Characteristics						

#### **Transfer Characteristics**

Parameter		Symbol	Symbol Min Typ. Max. Uni		Unit	Condition		
	H11AA1	CTR -	20	9 -		%		
Current Transfer ratio	H11AA2		10	1.			$I_F = \pm 10 \text{mA}, V_{CE} = 10 \text{V}$	
	H11AA3		50	-	-			
	H11AA4		100	-	-			
CTR Symmetry			0.5	-	2.0		I <sub>F</sub> = ±10mA ,V <sub>CE</sub> = 10V	
Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	-	-	0.4	V	$I_F = \pm 10$ mA , $I_C = 0.5$ mA	
Isolation resistance		R <sub>IO</sub>	10 <sup>11</sup>	-	-	Ω	V <sub>IO</sub> = 500Vdc, 40~60% R.H.	
Input-output capacitance		C <sub>IO</sub>	-	0.7	-	pF	V <sub>IO</sub> = 0, f = 1MHz	
Turn-on time		T <sub>on</sub>	-	-	10		V <sub>CC</sub> = 10V,	
Turn-off time		$T_{off}$	-	-	10			
Rise time		Tr	-	-	10	μs	$I_C = 10$ mA, $R_L = 100\Omega$	
Fall time		T <sub>f</sub>	-	-	10			

<sup>\*</sup> Typical values at T<sub>a</sub> = 25°C



### **Typical Electro-Optical Characteristics Curves**

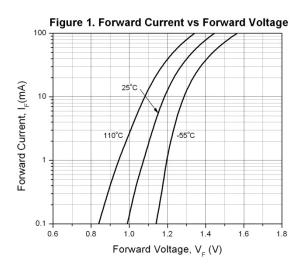


Figure 2. Current Tranfer Ratio vs Forward Current

1.2

0.6

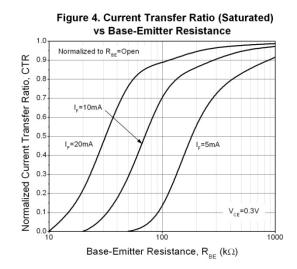
0.4

V<sub>ce</sub>=5 V

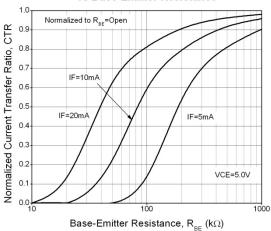
Ta=25°C

Normalized to I<sub>p</sub>=10 mA

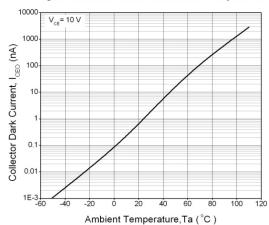
Forward Current, I<sub>E</sub> (mA)











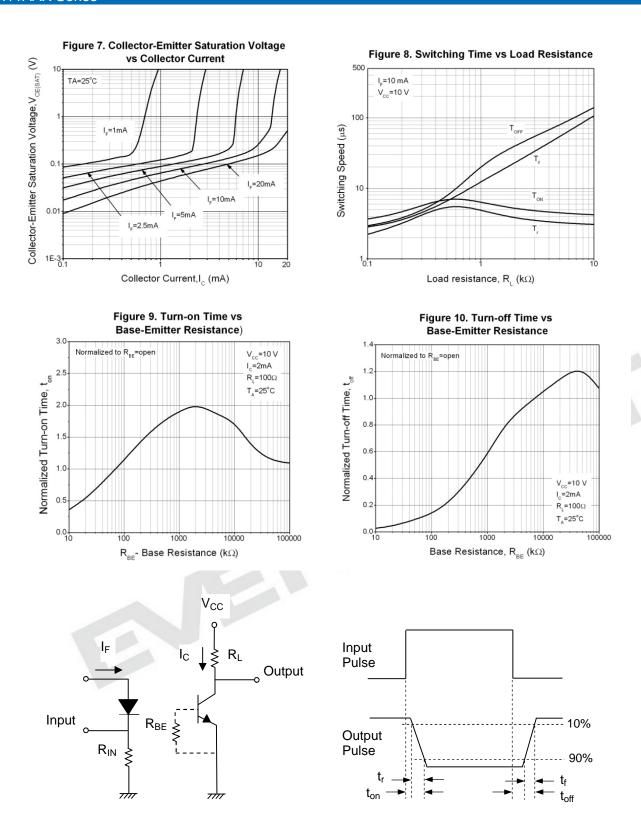


Figure 11. Switching Time Test Circuit & Waveforms



#### **Order Information**

#### **Part Number**

# H11AAXY(Z)-V

#### Note

Χ = CTR Rank (1, 2, 3, or 4)

= Lead form option (S, S1, M or none)

Z V = Tape and reel option (TA, TB, or none).

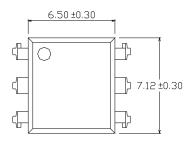
= VDE safety (optional).

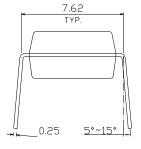
Option	Description	Packing quantity					
None	Standard DIP-6	65 units per tube					
М	Wide lead bend (0.4 inch spacing)	65 units per tube					
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel					
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel					
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel					
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel					

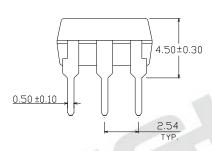


# Package Dimension (Dimensions in mm)

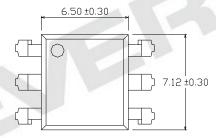
#### **Standard DIP Type**

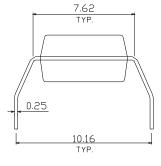


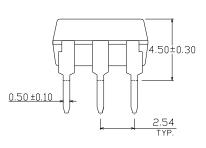




# **Option M Type**

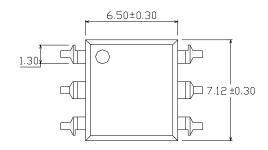


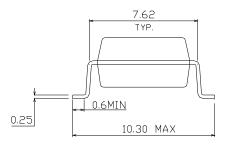


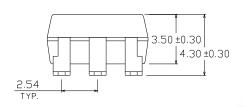




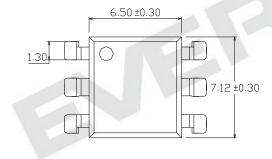
# **Option S Type**

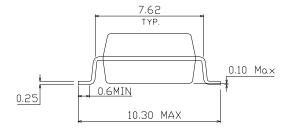


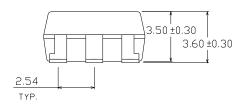




# **Option S1 Type**



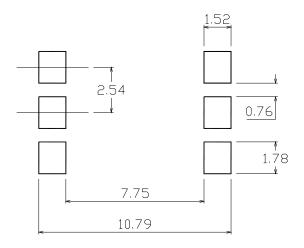




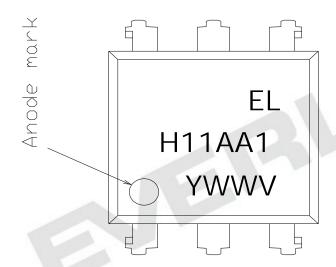
LifecyclePhase:



# Recommended pad layout for surface mount leadform



# **Device Marking**



#### **Notes**

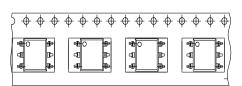
EL denotes Everlight
H11AA1 denotes Part Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE safety (optional)

**Expired Period: Forever** 



**Tape & Reel Packing Specifications** 

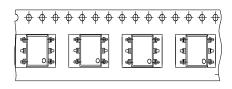
# **Option TA**





Direction of feed from reel

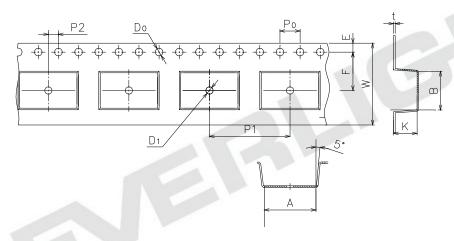
# **Option TB**





Direction of feed from reel

# **Tape dimensions**



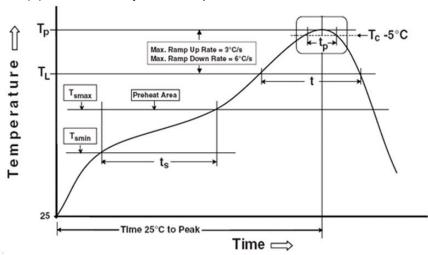
Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.5±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	К
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



#### **Precautions for Use**

#### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

#### **Preheat**

Temperature min  $(T_{smin})$  150 °C Temperature max  $(T_{smax})$  200 °C

Time  $(T_{smin} \text{ to } T_{smax})$   $(t_s)$  60-120 seconds Average ramp-up rate  $(T_{smax} \text{ to } T_p)$  3 °C/second max

Other

Liquidus Temperature (T<sub>L</sub>)

Time above Liquidus Temperature (t L)

Peak Temperature (T<sub>P</sub>)

Time within 5 °C of Actual Peak Temperature: T<sub>P</sub> - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

217 °C

60-100 sec

260°C

30 s

6°C /second max.

Reference: IPC/JEDEC J-STD-020D

8 minutes max.

3 times

11



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